

TE Internal #: 2198720-1

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 28 Gb/s,

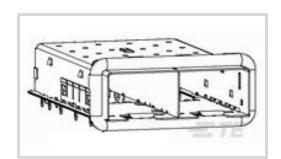
Elastomeric Gasket, EMI Enhanced, Not Optional, 1 x 2, None,

Through Hole - Press-Fit

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > zSFP+ Cage Assembly: Elastomeric Gasket



Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 28 Gb/s

EMI Containment Feature Type: Elastomeric Gasket

Pluggable I/O Applications: EMI Enhanced

Lightpipe Options: Not Optional

All zSFP+ Cage Assembly: Elastomeric Gasket (8)

Features

Product Type Features

Form Factor	zSFP+
Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Lightpipe Options	Not Optional
Connector System	Cable-to-Board
Sealable	Yes
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Port Matrix Configuration	1 x 2
Lightpipe Configuration	None
Number of Ports	2

Electrical Characteristics

Termination Features

Termination Post & Tail Length	2.05 mm[.081 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit

Mechanical Attachment



Housing Features Cage Material Nickel Silver Alloy Dimensions PCB Thickness (Recommended) 3 mm[.118 in] Usage Conditions FE. 105 °C [67 221 °F]
Dimensions PCB Thickness (Recommended) Usage Conditions 3 mm[.118 in]
PCB Thickness (Recommended) Usage Conditions 3 mm[.118 in]
Usage Conditions
Operating Temperature Pange
Operating Temperature Range -55 – 105 °C[-67 – 221 °F]
Operation/Application
Heat Sink Compatible No
For Use With Pluggable I/O Products zSFP+ SMT Connector
Pluggable I/O Applications EMI Enhanced
Circuit Application Signal
Packaging Features
Packaging Method Tray
Other
EMI Containment Feature Type Elastomeric Gasket

Product Compliance

For compliance documentation, visit the product page on TE.com>

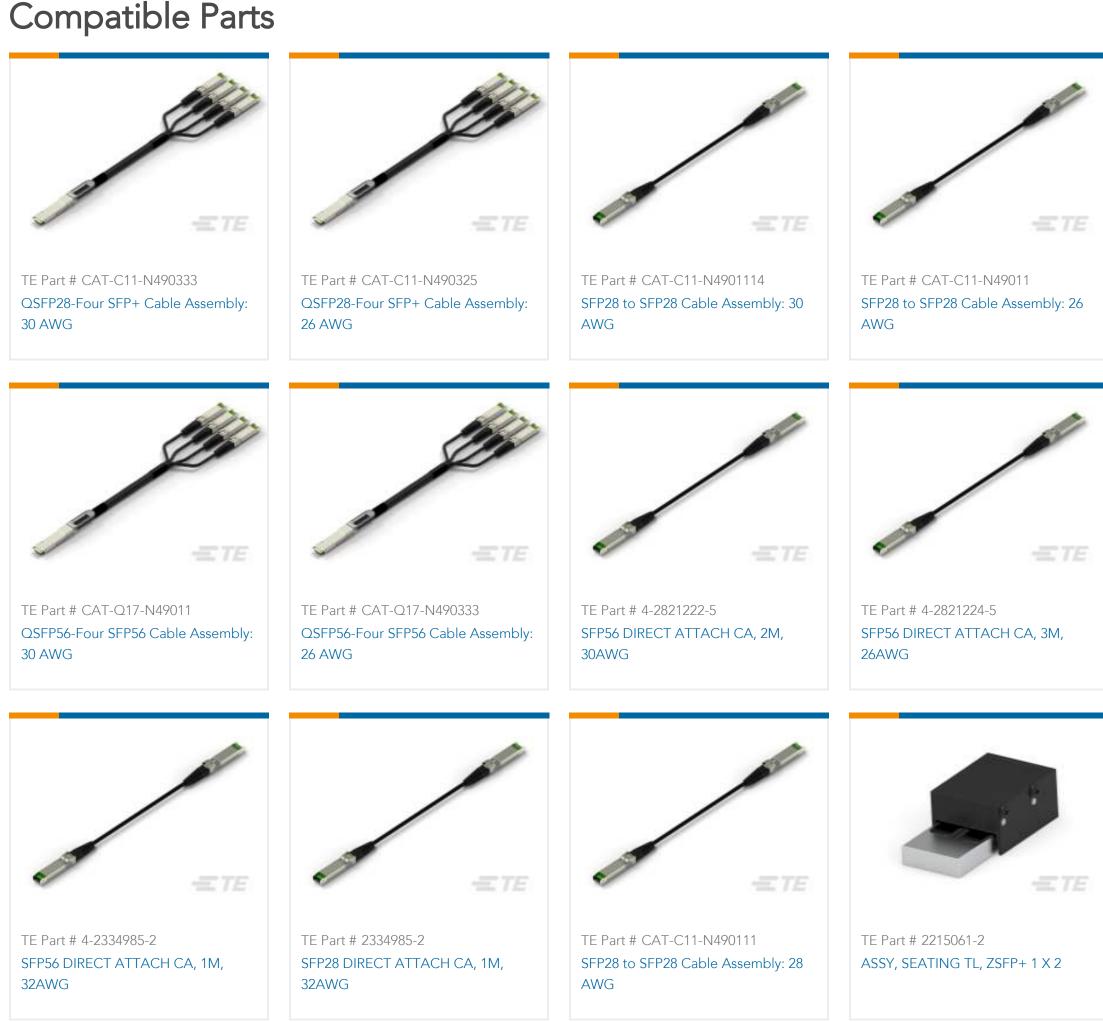
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent



chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.



Customers Also Bought





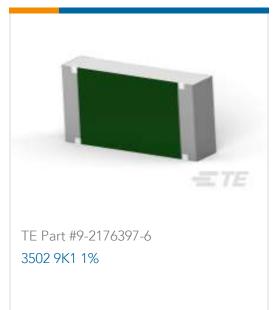














Documents

Product Drawings

zSFP+ 1x2 Cage Assembly, Press-Fit

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2198720-1_B.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2198720-1_B.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2198720-1_B.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

zSFP+ Interconnect Brochure

English

Product Specifications

Application Specification

English

Instruction Sheets

Instruction Sheet (U.S.)

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English

Instruction Sheet (U.S.)

English